

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[Molex Connector Corporation](#)
[53398-1390](#)

For any questions, you can email us directly:

sales@integrated-circuit.com

DWG. NO. SD-53398-10

E

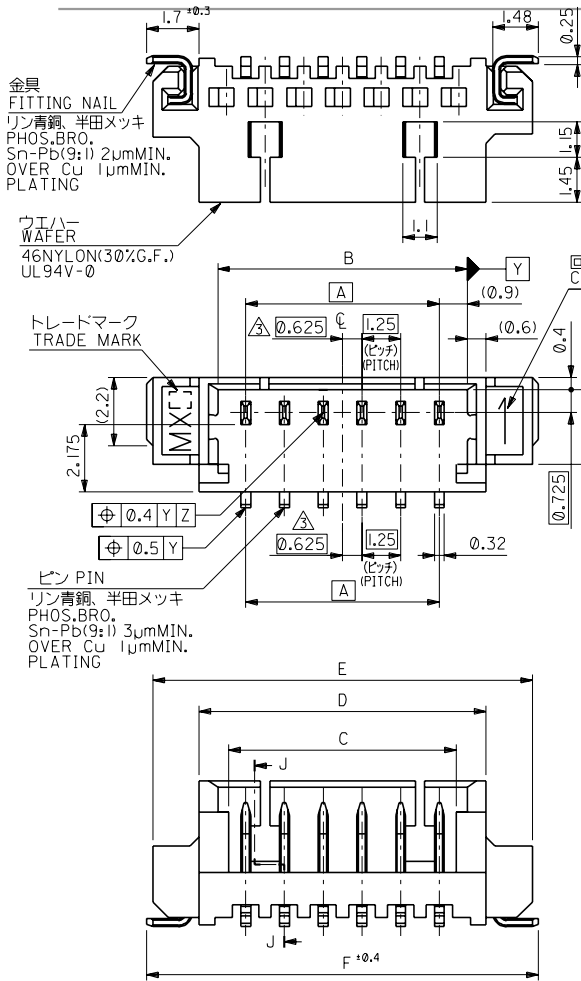
D

C

B

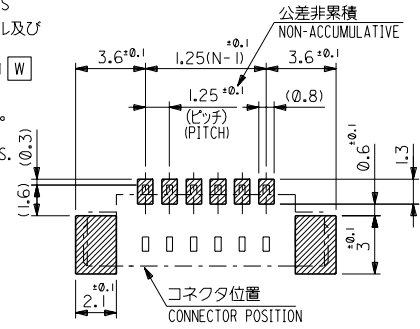
A

1MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING



注記 NOTES

1. 嵌合相手: 51021 シリーズ MATE WITH: 51021 SERIES
- △ 水平面上においての、ウェハー底面 [W] とソルダーテール及びフィッティングネイル底面とのズレ量を示す。
MISALIGNMENT OF SOLDER TAIL & FITTING NAIL FROM [W]
- △ 偶数極にのみ適用。APPLY EVEN CIRCUIT PRODUCTS.
- △ ロック窓は、2。3極は1ヶ所、4極以上は2ヶ所とする。
LOCKING WINDOW: ONE PLACE FOR 2&3 CKTS.
TWO PLACES FOR MORE THAN 4 CKTS.



23.9	23.5	20.5	18.6	19.3	17.5	53398-1510	15
22.65	22.25	19.25	17.35	18.05	16.25	-1410	14
21.4	21	18	16.1	16.8	15	-1310	13
20.15	19.75	16.75	14.85	15.55	13.75	-1210	12
18.9	18.5	15.5	13.6	14.3	12.5	-1110	11
17.65	17.25	14.25	12.35	13.05	11.25	-1010	10
16.4	16	13	11.1	11.8	10	-0910	9
15.15	14.75	11.75	9.85	10.55	8.75	-0810	8
13.9	13.5	10.5	8.6	9.3	7.5	-0710	7
12.65	12.25	9.25	7.35	8.05	6.25	-0610	6
11.4	11	8	6.1	6.8	5	-0510	5
10.15	9.75	6.75	4.85	5.55	3.75	-0410	4
8.9	8.5	5.5	3.6	4.3	2.5	-0310	3
7.65	7.25	4.25	2.35	3.05	1.25	53398-0210	2
F	E	D	C	B	A	ENG. NO.	極数 NO. OF CKTS.

F	変更 REVISED	UC2000-0630	K.K.	M.F.	00/3/30	材料 MATERIAL	図中参照 SEE DRAWING
E	変更 REVISED	UC2000-08	H.J.	M.F.	91/1/15	仕上げ FINISH	—
D	変更 REVISED	UC2000-30	H.J.	M.F.	93/10/15	適用電線範囲 WIRE RANGE	—
C	変更 REVISED	UC2000-75	K.T.	H.J.	93/1/29	被覆外径 INS. RANGE	—
B	変更 REVISED	UC2000-10	K.T.	H.J.	93/6/18	—	—
A	変更 REVISED	UC2000-230	K.T.	H.J.	93/3/12	—	—
0	新規作成 RELEASED	UC2000-240	K.T.	H.J.	92/10/12	DRAWN BY 92/10/12	CHK'D BY 00/3/30
1	社内承認 REVISION RECORD	—	DR.	DATE	92/10/12	K.T.OJO	T.YAMAGUCHI
2	社内承認 REVISION RECORD	—	DR.	DATE	92/10/12	M.FUKUSHIMA	—

角度 ANGLE	+30
30 以上 OVER	+0.3
10 以上 30 未満 OVER 30 UNDER	+0.25
10 未満 UNDER	+0.2
一般公差 GENERAL TOLERANCES	—

MOLEX-JAPAN CO., LTD. 日本モレックス株式会社
REVISE ONLY ON CAD SYSTEM
TITLE 名称
1.25 WIRE TO BOARD CONN. WAFER ASS'Y FOR SMT (ST.)
DWG. NO. SD-53398-10
REV F

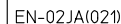
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EN-01C(032)MXJ-32

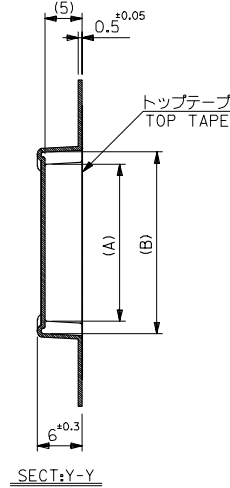
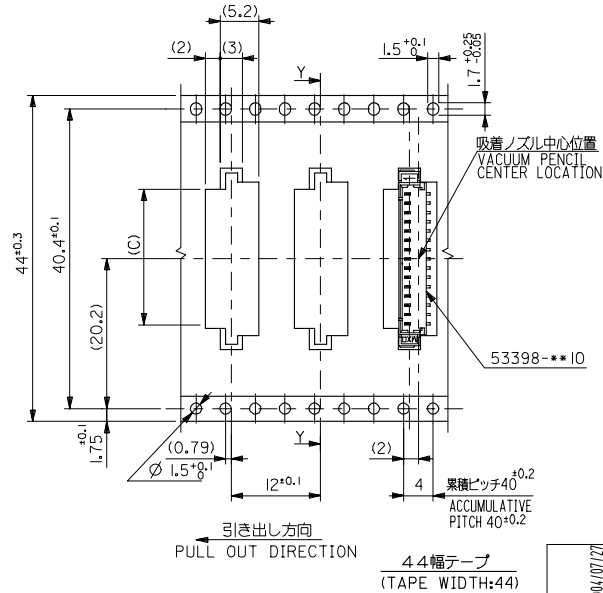
10 9 8 7 6 5 4 3 2 1

23.9	23.5	20.5	18.6	19.3	17.5	53398-1571	15
22.65	22.25	19.25	17.35	18.05	16.25	53398-1471	14
21.4	21	18	16.1	16.8	15	53398-1371	13
20.15	19.75	16.75	14.85	15.55	13.75	53398-1271	12
18.9	18.5	15.5	13.6	14.3	12.5	53398-1171	11
17.65	17.25	14.25	12.35	13.05	11.25	53398-1071	10
16.4	16	13	11.1	11.8	10	53398-0971	9
15.15	14.75	11.75	9.85	10.55	8.75	53398-0871	8
13.9	13.5	10.5	8.6	9.3	7.5	53398-0771	7
12.65	12.25	9.25	7.35	8.05	6.25	53398-0671	6
11.4	11	8	6.1	6.8	5	53398-0571	5
10.15	9.75	6.75	4.85	5.55	3.75	53398-0471	4
8.9	8.5	5.5	3.6	4.3	2.5	53398-0371	3
7.65	7.25	4.25	2.35	3.05	1.25	53398-0271	2
F	E	D	C	B	A	EMBOSSED TAPE PKG. (HIGH BARRIER PKG.) ORDER No.	種別 No. of CKTS.

CONNECTOR SERIES NO. 53398-***19

REVISED	EC NO. J2010-0213	DRAWN BY CHKD/NIKITA	DATE 2009/09/25	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION					
					10 UNDER	± 0.2	DRAWN BY MNINOMIYA	DATE 04/02/06	TITLE 1.25 W/B CONN. ASS'Y FOR SMT(ST.) -LEAD FREE-							
					10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE 04/02/06								
					30 OVER	± 0.3	APPROVED BY MSASAO	DATE 04/02/06	MOLEX INCORPORATED							
					ANGULAR	± 3 °	MATERIAL NO.	SEE TABLE						DOCUMENT NO. SD-53398-032		SHEET NO. 2 OF 2
					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
					REV	SIZE A3										





44	45.4	18.7	24.5	20.8	53398-1590	15
キャリアテープ幅 CARRIER TAPE WIDTH	D	(C)	(B)	(A)	ENG. NO.	種別 CKT.
		17.45	23.25	19.55	53398-1490	14

REVISED EC NO: T1 DRAWN BY CHKD: ASAKAWA 2004/07/28 APPR: CHIKAMA 2004/07/30	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY K. TOJO	DATE '93/04/13	TITLE 1.25 W/B CONN. WAFER ASS'Y FOR SMT. EMBOSSSED TAPE PACKAGE  MOLEX INCORPORATED			
		10 OVER 30 UNDER	±0.25	CHECKED BY YAMAGUCHI	DATE '00/12/08				
		30 OVER	±0.3	APPROVED BY FUKUSHIM	DATE '00/12/08				
		ANGULAR	±3 °	MATERIAL NO.					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-53398-**90		SHEET NO. 3 OF 3	
				SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			